

Power Schottky rectifier

Main product characteristics

$I_{F(AV)}$	2 x 7.5 A
V_{RRM}	45 V
T_j (max)	175° C
V_F (max)	0.57 V

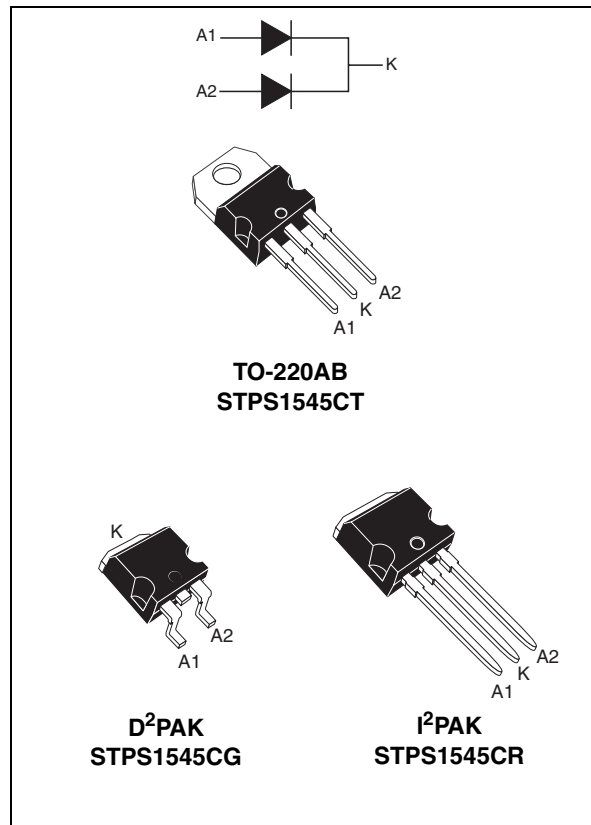
Features and Benefits

- Very small conduction losses
- Negligible switching losses
- Extremely fast switching
- Avalanche capability specified

Description

Dual center tap Schottky rectifier suited for SwitchMode Power Supply and high frequency DC to DC converters.

Packaged either in TO-220AB, D²PAK or I²PAK, this device is especially intended for use in low voltage, high frequency inverters, free wheeling and polarity protection applications.



1 Characteristics

Table 1. Absolute Ratings (limiting values)

Symbol	Parameter			Value	Unit
V _{RRM}	Repetitive peak reverse voltage			45	V
I _{F(RMS)}	RMS forward voltage			20	A
I _{F(AV)}	Average forward current $\delta = 0.5$	T _c = 157° C	Per diode	7.5	A
I _{FSM}	Surge non repetitive forward current	t _p = 10 ms Sinusoidal		150	A
I _{RRM}	Peak repetitive reverse current	t _p = 2 μ s square F = 1 kHz		1	A
I _{RSM}	Non repetitive peak reverse current	t _p = 100 μ s square		2	A
P _{ARM}	Repetitive peak avalanche power	t _p = 1 μ s T _j = 25°C		2700	W
T _{stg}	Storage temperature range			-65 to + 175	°C
T _j	Maximum operating junction temperature ⁽¹⁾			175	°C
dV/dt	Critical rate of rise of reverse voltage			10000	V/ μ s

1. $\frac{dP_{tot}}{dT_j} < \frac{1}{R_{th(j-a)}}$ thermal runaway condition for a diode on its own heatsink

Table 2. Thermal resistances

Symbol	Parameter		Value	Unit
R _{th(j-c)}	Junction to case	Per diode	3.0	°C/W
		Total	1.7	
R _{th(c)}		Coupling	0.35	

When the diodes 1 and 2 are used simultaneously :
 $\Delta T_j(\text{diode 1}) = P(\text{diode1}) \times R_{th(j-c)}(\text{Per diode}) + P(\text{diode 2}) \times R_{th(c)}$

Table 3. Static electrical characteristics (per diode)

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage current	T _j = 25°C	V _R = V _{RRM}			100	μ A
		T _j = 125°C			5	15	mA
V _F ⁽¹⁾	Forward voltage drop	T _j = 125°C	I _F = 7.5A		0.5	0.57	V
		T _j = 25°C	I _F = 15 A			0.84	
		T _j = 125°C	I _F = 15 A		0.65	0.72	

1. Pulse test: t_p = 380 μ s, $\delta < 2\%$

To evaluate the conduction losses use the following equation:

$$P = 0.42 \times I_{F(AV)} + 0.020 I_{F(RMS)}^2$$

Figure 1. Average forward power dissipation versus average forward current (per diode)

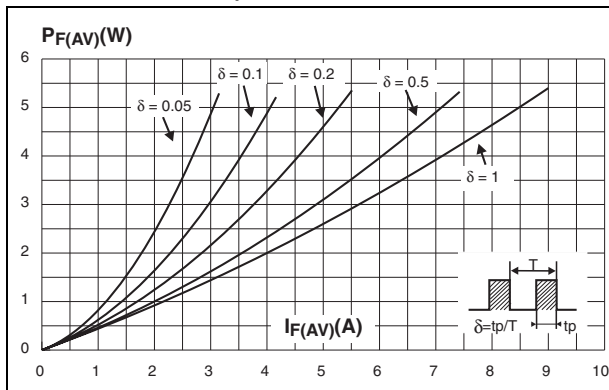


Figure 2. Average forward current versus ambient temperature ($\delta = 0.5$, per diode)

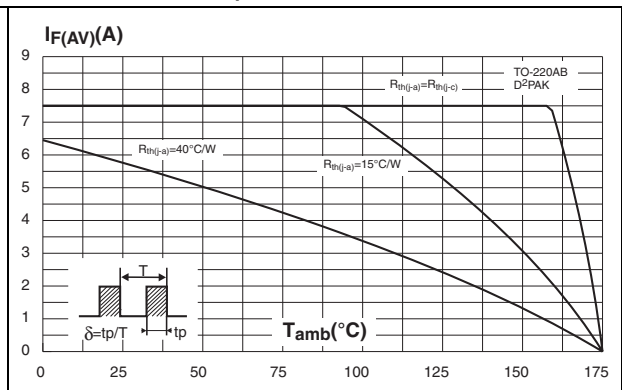


Figure 3. Normalized avalanche power derating versus pulse duration

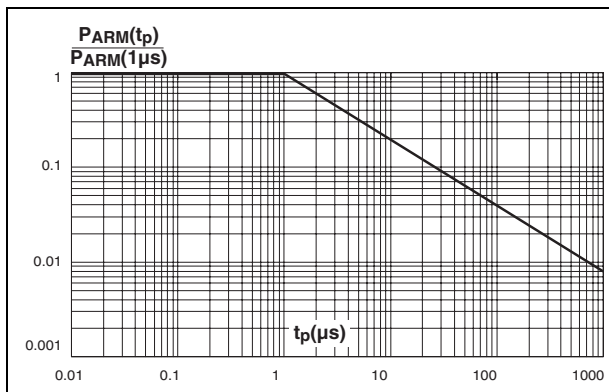


Figure 4. Normalized avalanche power derating versus junction temperature

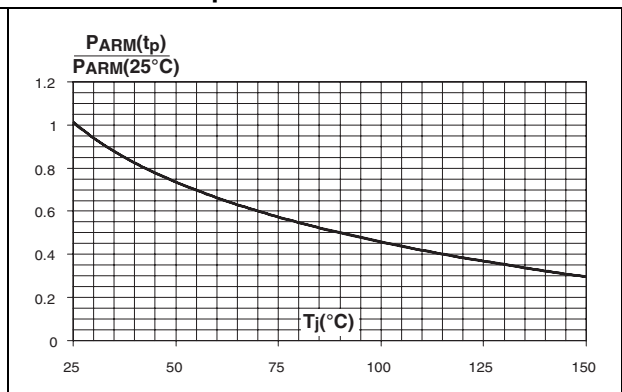


Figure 5. Non repetitive surge peak forward current versus overload duration (maximum values, per diode)

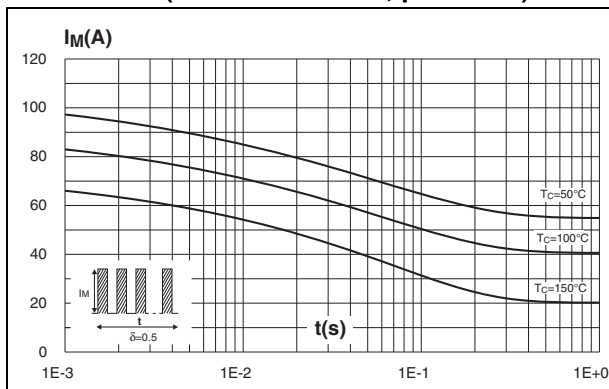


Figure 6. Relative variation of thermal impedance junction to case versus pulse duration

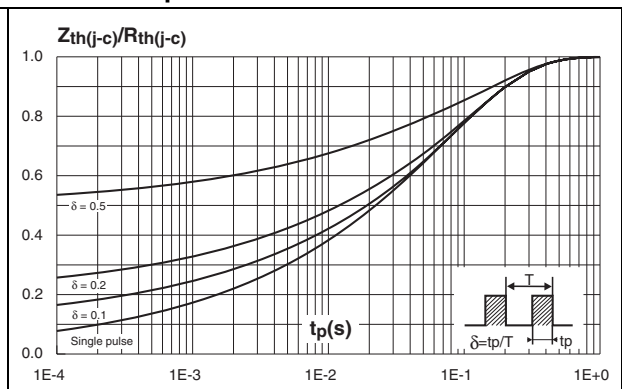


Figure 7. Reverse leakage current versus reverse voltage applied (typical values, per diode)

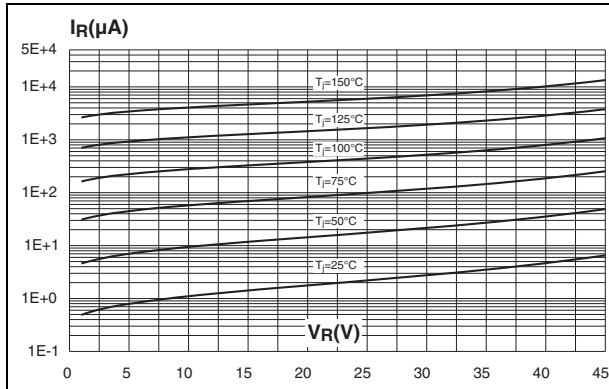


Figure 8. Junction capacitance versus reverse voltage applied (typical values, per diode)

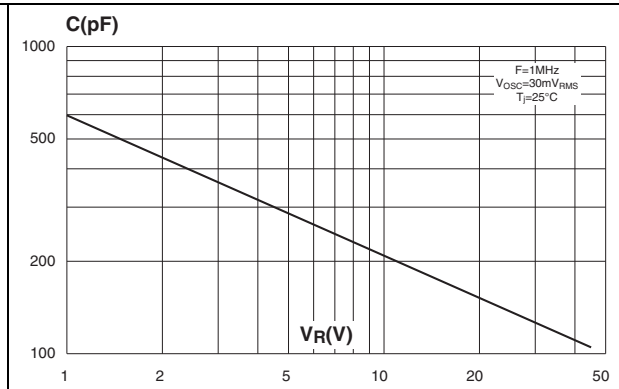


Figure 9. Forward voltage drop versus forward current (maximum values, per diode)

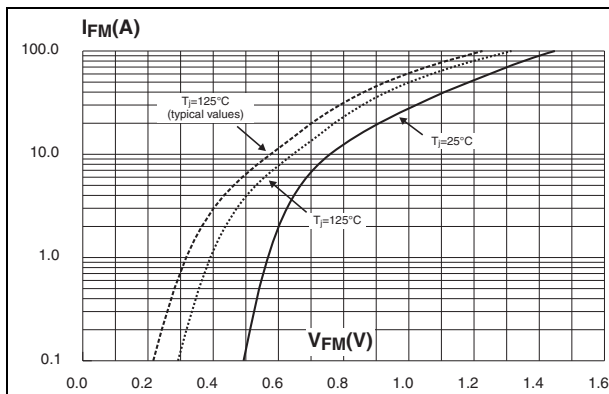
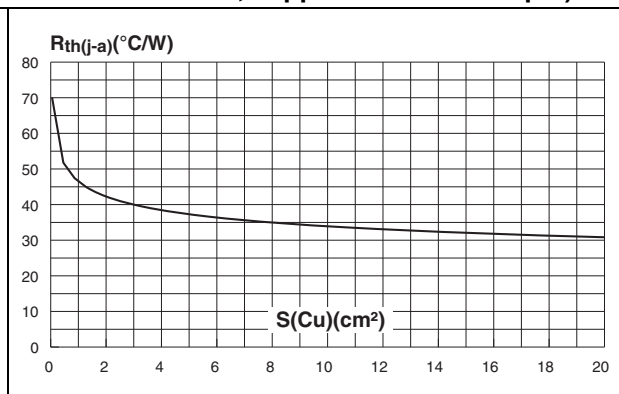


Figure 10. Thermal resistance junction to ambient versus copper surface under tab (Epoxy printed circuit board, copper thickness: 35 μm)



2 Package Information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.55 Nm
- Maximum torque value: 0.70 Nm

Figure 11. D²PAK dimensions

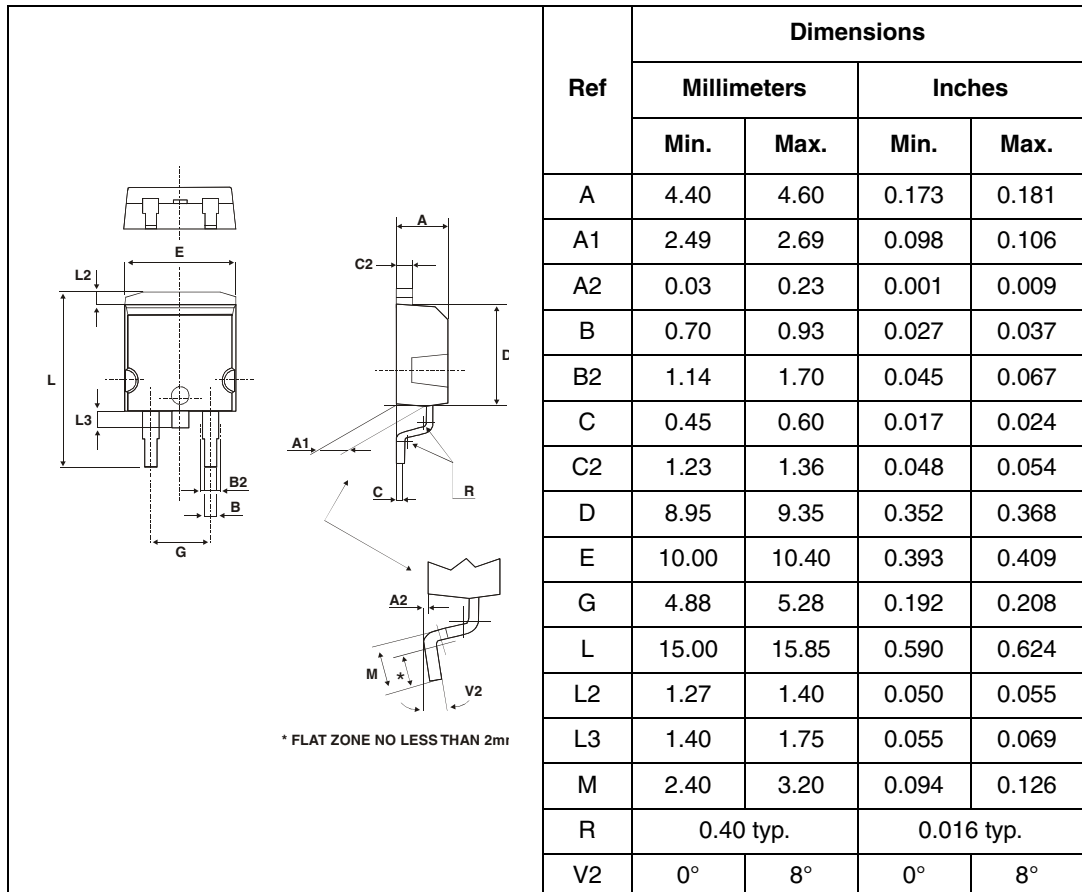


Figure 12. Footprint (dimensions in millimeters)

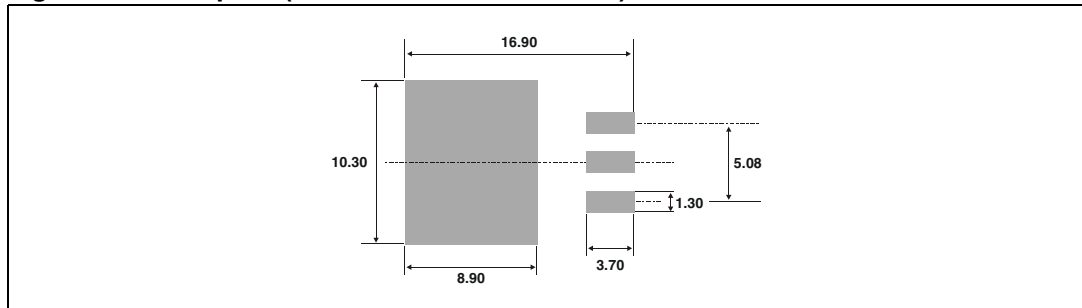


Figure 13. TO-220AB dimensions

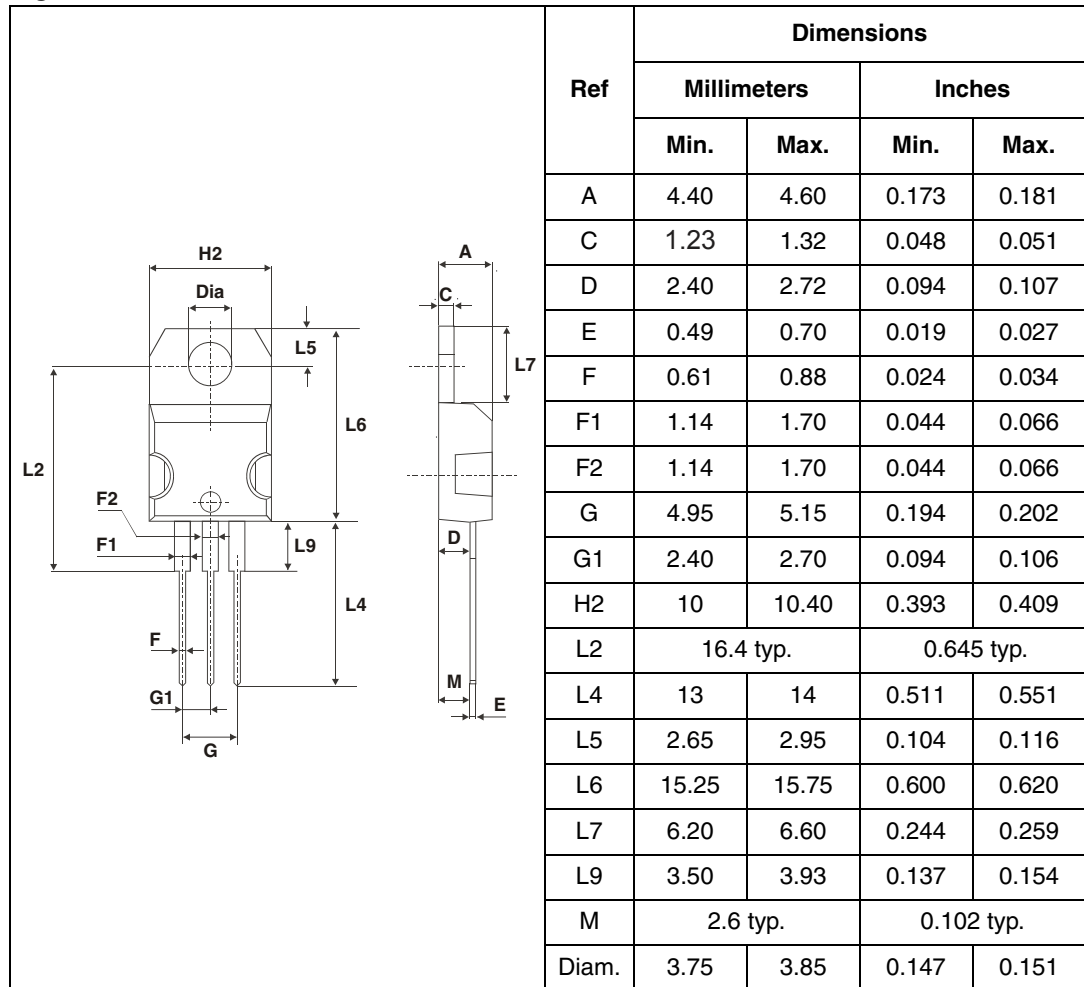
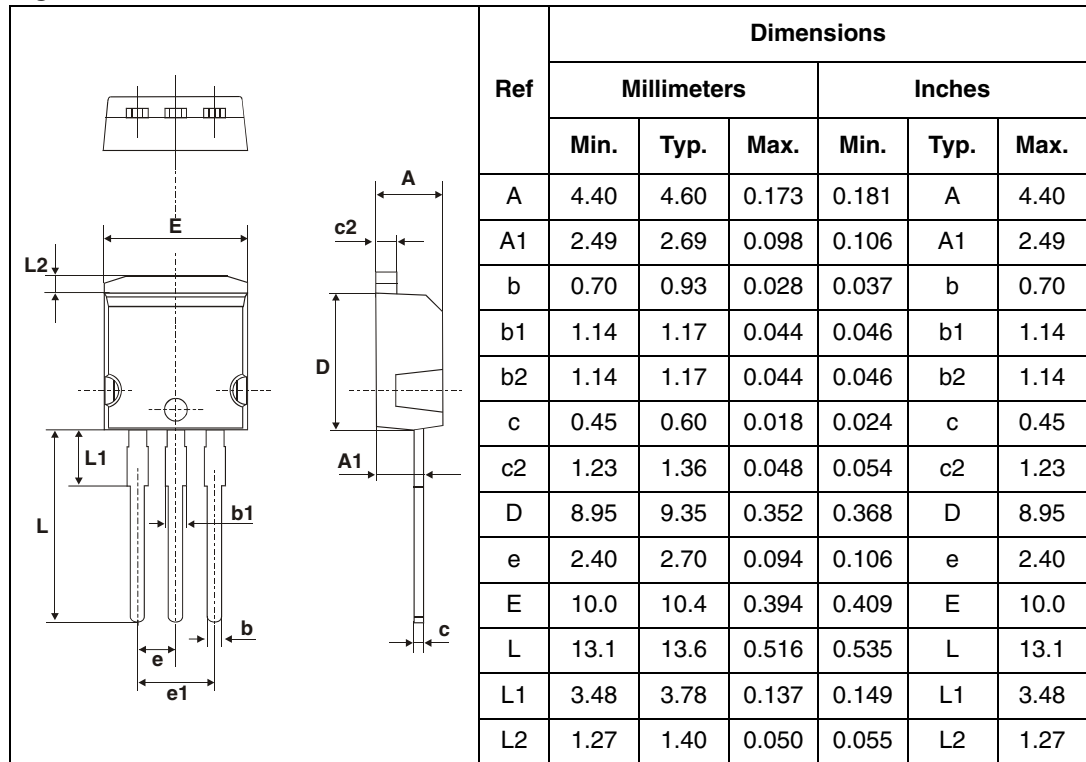


Figure 14. I²PAK dimensions



In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

3 Ordering Information

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STPS1545CT	STPS1545CT	TO-220AB	2.23 g	50	Tube
STPS1545CG	STPS1545CG	D ² PAK	1.48 g	50	Tube
STPS1545CG-TR	STPS1545CG	D ² PAK	1.48 g	1000	Tape & reel
STPS1545CR	STPS1545CR	I ² PAK	1.49 g	50	Tube

4 Revision history

Date	Revision	Description of Changes
Jul-2003	5F	Last release.
21-Mar-2007	6	Removed ISOWATT and TO-220FPAB packages.

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